

4G PRODUCT

CM2

PRODUCT SPECIFICATIONS



Note: Due to product version upgrades and other reasons, the contents of this document may be updated without prior notice. Unless otherwise agreed, all statements, information, and recommendations in this document do not constitute any warranty, express or implied.

□ Appearance



□ Application scenarios



□ Specifications

Hardware Platform	Chipset	G306
Protocol	LTE TDD/FDD	Cat. 1, Downlink/Uplink up to 10Mbps/5Mbps
RF BAND	Band1	LTE FDD: B1/ B3 /B5 /B8 LTE TDD: B34/B38/B39/B40/B41
	Band2	LTE FDD: B1/B3/B5/B7/B8/B20/B28(28A、28B) LTE TDD: B38/B40/B41
Antenna	Internal Antenna connector	LTE Main*1
External Interface	SIM SIM card slot	Nano SIM card and Esim
	Power interface	DC
	RJ45	LAN
Indicator	LED indicator	SYS/4G
Power Supply	DC	5-28V
Software		
WEB UI	Device Status	Supported
	APN Setting	Supported
	SIM card switch	Supported
	Online keeper	Supported
	Reboot	Supported
	Restore factory	Supported
	Local upgrade	Supported
Environment	Working Temperature	0~45℃
	Storage Temperature	-20~70℃